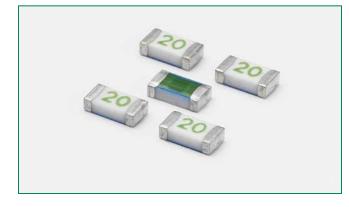


501 Slim Series – High Current 1206 Fast-Acting Fuse



Agency Approvals					
AGENCY	AGENCY FILE NUMBER	AMPERE RANGE			
91	E10480	10A - 20A			
۲.	29862	10A - 20A			

Electrical Characteristics for Series				
% of Ampere Rating	Ampere Rating	Opening Time at 25%		
100%	10A – 20A	4 Hours, Minimum		

10A – 20A

Additional Information



350%





5 Seconds, Maximum



Description

The 501 Series is a 100% Lead-free, RoHS compliant and Halogen-free fuse series designed specifically to provide over- current protection to circuits that operate under high working ambient temperature up to 150°C.

The general design ensures excellent temperature stability and performance reliability.

The high I²t values which is typical in the Littelfuse Ceramic Fuse family, ensure high inrush current withstand capability.

Features

- Operating Temperature from -55°C to +150°C
- 100% Lead-free, RoHS compliant and Halogenfree

RoHS 🔞 HF 🔁 🚯

- Designed to provide over-current protection in high current voltage regulator module (VRM) applications
- compliant and HalogenfreeSuitable for both leaded
- Suitable for both leaded and lead-free reflow/wave soldering

Applications

- Voltage Regulator Module (VRM) Equipment
- Notebook PC
- DC-DC Converter

Electrical Specifications by Item

Ampere Max. Voltage		Interrupting	Nominal Nomi	Nominal	Iominal Nominal Voltage	Nominal Power	Agency Approvals		
Rating (A)	Amp Code	Rating (V)	Rating (DC) ¹	Resistance Melting I ² T (Ohms) ² (A ² Sec.) ³	Drop At Rated Current (V) ⁴	Dissipation At Rated Current (W)	7 1	۹.	
10	010.	32	150A @ 32VDC	0.00427	10.385	0.05679	0.5679	X	х
12	012.	32		0.00321	20.341	0.04891	0.5870	X	х
15	015.	32		0.00250	36.100	0.04605	0.6908	X	х
20	020.	32		0.00200	54.760	0.05936	1.1871	X	х

Notes:

1. DC Interrupting Rating tested at rated voltage with time constant < 0.5 msec.

2. Nominal Resistance measured with < 10% rated current.

3. Nominal Melting I²t measured at 1 msec. opening time. For other I²t data refer to chart.

 Nominal Voltage Drop measured at rated current after temperature has stabilized and with fuse mounted on board with 3-oz Cu trace. Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-rating Curve" for additional re-rating information.

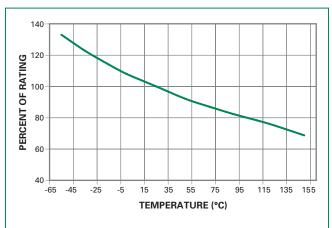
Devices designed to be mounted with marking code facing up.

Surface Mount Fuses

Ceramic Fuse > 501 Series







Note:

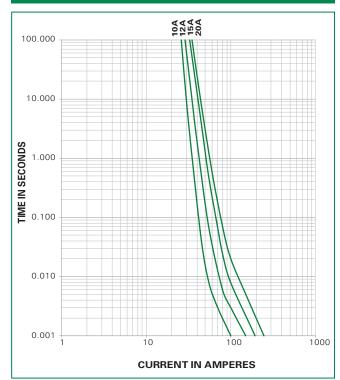
1. Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation.

Example:

For continuous operation at 75 degrees celsius, the fuse should be rerated as follows:

 $\mathsf{I} = (0.80)(0.85)\mathsf{I}_{\mathsf{RAT}} = (0.68)\mathsf{I}_{\mathsf{RAT}}$

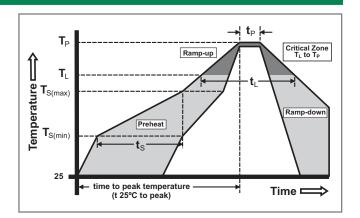
Average Time Current Curves



Soldering Parameters

ndition	Pb – free assembly	
-Temperature Min (T _{s(min)})	150°C	
-Temperature Max (T _{s(max)})	200°C	
-Time (Min to Max) (t _s)	60 – 180 seconds	
amp-up Rate (LiquidusTemp x)	5°C/second max.	
- Ramp-up Rate	5°C/second max.	
-Temperature (T _L) (Liquidus)	217°C	
-Temperature (t _L)	60 – 150 seconds	
erature (T _P)	260 ^{+0/-5} °C	
n 5°C of actual peak re (t _p)	20 – 40 seconds	
n Rate	5°C/second max.	
to peakTemperature (T _P)	8 minutes max.	
eed	260°C	
	-Temperature Min (T _{s(min)}) -Temperature Max (T _{s(max)}) -Time (Min to Max) (t _s) mp-up Rate (Liquidus Temp) - Ramp-up Rate -Temperature (T _L) (Liquidus) -Temperature (t _L) erature (T _P) n 5°C of actual peak re (t _p) n Rate to peakTemperature (T _P)	

Wave Soldering	260°C, 10 seconds max.
wave Soldening	200 C, 10 Seconds max.



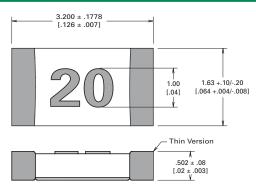


Product Characteristics

Materials	Body: Advanced Ceramic Terminations: Ag / Ni / Sn (100% Lead-free) Element Cover Coating: Lead-free Glass		
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1		
Solderability	IPC/ECA/JEDEC J-STD-002, Condition B		
Humidity Test	MILSTD-202, Method 103, Conditions D		
Resistance to Solvents	MIL-STD-202, Method 210, Condition B		

Moisture Resistance	MIL-STD-202, Method 106	
Thermal Shock	MIL-STD-202, Method 107, Condition B	
Mechanical Shock	MIL-STD-202, Method 213, Condition A	
Vibration	MIL-STD-202, Method 201	
Vibration, High Frequency	MIL-STD-202, Method 204, Condition D	
Dissolution of Metallization	IPC/ECA/JEDEC J-STD-002, Condition D	
Terminal Strength	IEC 60127-4	

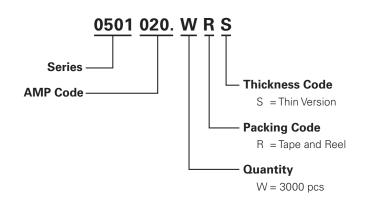
Dimensions



Dissolution of Metallization		IPC/ECA/JEDEC J-S ⁻ Condition D	
Terminal Strength		IEC 60127-4	
Part Marking	System		
Amp Code	Markin	g Code	
010.	1	0	

	J
010.	10
012.	12
015.	15
020.	20

Part Numbering System



TERMINATI	ON
.520 ± .200 [.020 ± .008]	
1.000 [.039] [.059]	
3.500	

Packaging

Packaging Option	Packaging Specification	Quantity	Quantity and Packaging Code
8mm Tape and Reel	EIA-481, IEC 60286, Part 3	3000	WRS